

PATENT ASSIGNMENT

Electronic Version v08

Stylesheet Version v02

SUBMISSION TYPE:

NEW ASSIGNMENT

APPLICATION NUMBER

11/161648

NATURE OF CONVEYANCE:

ASSIGNMENT OF ASSIGNOR'S INTEREST

CONVEYING PARTY DATA

Name	Execution Date
Chien-Lung Chu	2005-04-08
Saysamone Pittikoun	2005-04-11
Houng-Chi Wei	2005-04-08
Wei-Chung Tseng	2005-04-08

RECEIVING PARTY DATA

Name	Street Address	Internal Address	City	State/Country	Postal Code
Powerchip Semiconductor Corp.	No. 12, Li-Hsin Rd. I, Science-Based Industrial Park		Hsinchu	TAIWAN	

CORRESPONDENCE DATA

FAX NUMBER: 886223697233

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the official record on file at the USPTO.

CUSTOMER NUMBER: 031561

NAME OF PERSON SIGNING:

Belinda Lee

DATE SIGNED:

2005-08-10

Total Attachments: 2

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PATENT
REEL: 016383 FRAME: 0925

ASSIGNMENT

WHEREAS,

1. Chien-Lung Chu
3. Houn-g-Chi Wei

2. Saysamone Pittikoun
4. Wei-Chung Tseng

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **METHOD OF FABRICATING NON-VOLATILE MEMORY**

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, Powerchip Semiconductor Corp.
of No. 12, Li-Hsin Rd. I, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: CHIEN LUNG CHU

Date: 2005 04 08

Sole or First Joint Inventor: Chien-Lung Chu

Signature: Saysamone Pittikoun

Date: 2005 . April . 11

Second Joint Inventor(if any): Saysamone Pittikoun

Signature: HOUNG - CHI WEI

Date: 2005 04 08 .

Third Joint Inventor(if any): HOUNG-Chi Wei

Signature: Wei-Chung Tseng

Date: 2005 04 08

Fourth Joint Inventor(if any): Wei-Chung Tseng